

**Enhanced Product**
**ADG658-EP**
**FEATURES**

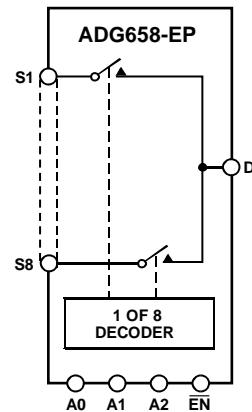
- $\pm$ 2 V to  $\pm$ 6 V dual supply**
- 2 V to 12 V single supply**
- <0.1 nA leakage currents (typical)**
- 45  $\Omega$  typical on resistance over full signal range**
- Rail-to-rail switching operation**
- Single, 8 to 1 multiplexer**
- 16-lead TSSOP package**
- 0.01  $\mu$ A typical supply current**
- TTL/CMOS compatible inputs**

**ENHANCED PRODUCT FEATURES**

- Supports defense and aerospace applications (AQEC standard)**
- Military temperature range:  $-55^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$**
- Controlled manufacturing baseline**
- One assembly/test site**
- One fabrication site**
- Enhanced product change notification**
- Qualification data available on request**

**APPLICATIONS**

- Automatic test equipment**
- Data acquisition systems**
- Battery-powered systems**
- Communication systems**
- Audio and video signal routing**
- Relay replacement**
- Sample-and-hold systems**
- Industrial control systems**

**FUNCTIONAL BLOCK DIAGRAM**


SWITCHES SHOWN FOR A LOGIC 1 INPUT. 15881-001

Figure 1.

**GENERAL DESCRIPTION**

The ADG658-EP is a low voltage, CMOS analog multiplexer comprised of eight single channels. The ADG658-EP switches one of eight inputs (S1 to S8) to a common output, D, as determined by the 3-bit binary address lines A0, A1, and A2. An EN input enables or disables the device. When disabled, all channels are switched off.

The ADG658-EP is designed on an enhanced process that provides lower power dissipation yet gives high switching speeds. It can operate equally well as either a multiplexer or a demultiplexer, and has an input range that extends to the supplies. All channels exhibit break-before-make switching action, preventing momentary shorting when switching channels. All digital inputs have +0.8 V to +2.4 V logic thresholds, ensuring TTL/CMOS logic compatibility when using single +5 V or dual  $\pm$ 5 V supplies.

The ADG658-EP is available in a 16-lead TSSOP package.

Additional application and technical information can be found in the [ADG658](#) data sheet.

**PRODUCT HIGHLIGHTS**

1. Single-supply and dual-supply operation. The ADG658-EP offers high performance and is fully specified and guaranteed with  $\pm$ 5 V, +5 V, and +3 V supply rails.
2. Military temperature range  $-55^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ .
3. Low supply current, typically 0.01  $\mu$ A.
4. 16-lead TSSOP package.

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## REVISION HISTORY

8/2017—Revision 0: Initial Version

## SPECIFICATIONS

### DUAL SUPPLY

$V_{DD} = 5 \text{ V} \pm 10\%$ ,  $V_{SS} = -5 \text{ V} \pm 10\%$ , GND = 0 V, unless otherwise noted.

Table 1.

Parameter	+25°C	-55°C to +125°C	Unit	Test Conditions/Comments
<b>ANALOG SWITCH</b>				
Analog Signal Range		$V_{SS}$ to $V_{DD}$	V	$V_{DD} = +4.5 \text{ V}$ , $V_{SS} = -4.5 \text{ V}$
On Resistance, $R_{ON}$	45 75	100	$\Omega$ typ $\Omega$ max	Source voltage ( $V_S$ ) = $\pm 4.5 \text{ V}$ , source current ( $I_S$ ) = 1 mA
On Resistance Match Between Channels, $\Delta R_{ON}$	1.3	3.5	$\Omega$ typ $\Omega$ max	$V_S = 3.5 \text{ V}$ , $I_S = 1 \text{ mA}$
On Resistance Flatness, $R_{FLAT(ON)}$	10 16	18	$\Omega$ typ $\Omega$ max	$V_{DD} = +5 \text{ V}$ , $V_{SS} = -5 \text{ V}$ $V_S = \pm 3 \text{ V}$ , $I_S = 1 \text{ mA}$
<b>LEAKAGE CURRENTS</b>				
Source Off Leakage, $I_S$ (OFF)	$\pm 0.005$		nA typ	$V_{DD} = +5.5 \text{ V}$ , $V_{SS} = -5.5 \text{ V}$
	$\pm 0.2$	$\pm 5$	nA max	Drain voltage ( $V_D$ ) = $\pm 4.5 \text{ V}$ , $V_S = \mp 4.5 \text{ V}$
Drain Off Leakage, $I_D$ (OFF)	$\pm 0.005$		nA typ	$V_D = \pm 4.5 \text{ V}$ , $V_S = \mp 4.5 \text{ V}$
	$\pm 0.2$	$\pm 5$	nA max	
Channel On Leakage $I_D$ , $I_S$ (ON)	$\pm 0.005$ $\pm 0.2$	$\pm 5$	nA typ nA max	$V_D = V_S = \pm 4.5 \text{ V}$
<b>DIGITAL INPUTS</b>				
Input High Voltage, $V_{INH}$		2.4	V min	
Input Low Voltage, $V_{INL}$		0.8	V max	
Input Current $I_{INL}$ or $I_{INH}$	0.005	$\pm 1$	$\mu\text{A}$ typ $\mu\text{A}$ max	Input voltage ( $V_{IN}$ ) = $V_{INL}$ or $V_{INH}$
Digital Input Capacitance, $C_{IN}$	2		pF typ	
<b>DYNAMIC CHARACTERISTICS<sup>1</sup></b>				
Transition Time, $t_{TRANSITION}$	80		ns typ	Load resistance ( $R_L$ ) = 300 $\Omega$ , load capacitance ( $C_L$ ) = 35 pF
	115	165	ns max	$V_S = 3 \text{ V}$
$\overline{\text{EN}}$ On Time, $t_{ON}(\overline{\text{EN}})$	80		ns typ	$R_L = 300 \Omega$ , $C_L = 35 \text{ pF}$
	115	165	ns max	$V_S = 3 \text{ V}$
$\overline{\text{EN}}$ Off Time, $t_{OFF}(\overline{\text{EN}})$	30		ns typ	$R_L = 300 \Omega$ , $C_L = 35 \text{ pF}$
	45	55	ns max	$V_S = 3 \text{ V}$
Break-Before-Make Time Delay, $t_{BBM}$	50	10	ns typ ns min	$R_L = 300 \Omega$ , $C_L = 35 \text{ pF}$ Source 1 voltage ( $V_{S1}$ ) = 3 V, source 2 voltage ( $V_{S2}$ ) = 3 V
Charge Injection	2		$\text{pC}$ typ	$V_S = 0 \text{ V}$ , $R_S = 0 \Omega$
	4		$\text{pC}$ max	$C_L = 1 \text{ nF}$
Off Isolation	-90		$\text{dB}$ typ	$R_L = 50 \Omega$ , $C_L = 5 \text{ pF}$ , $f = 1 \text{ MHz}$
Total Harmonic Distortion Plus Noise, THD + N -3 dB Bandwidth	0.025		% typ	$R_L = 600 \Omega$ , 2 V p-p, $f = 20 \text{ Hz}$ to $20 \text{ kHz}$
	210		MHz typ	$R_L = 50 \Omega$ , $C_L = 5 \text{ pF}$
Source Capacitance, $C_S$ (OFF)	4		pF typ	$f = 1 \text{ MHz}$
Drain Capacitance, $C_D$ (OFF)	23		pF typ	$f = 1 \text{ MHz}$
$C_D$ , $C_S$ (ON)	28		pF typ	$f = 1 \text{ MHz}$
<b>POWER REQUIREMENTS</b>				
Positive Power Supply Current, $I_{DD}$	0.01	1	$\mu\text{A}$ typ $\mu\text{A}$ max	$V_{DD} = +5.5 \text{ V}$ , $V_{SS} = -5.5 \text{ V}$ Digital inputs = 0 V or 5.5 V
Negative Power Supply Current, $I_{SS}$	0.01	1	$\mu\text{A}$ typ $\mu\text{A}$ max	Digital inputs = 0 V or 5.5 V

<sup>1</sup> Guaranteed by design; not subject to production test.

**5 V SINGLE SUPPLY**

$V_{DD} = 5 \text{ V} \pm 10\%$ ,  $V_{SS} = 0 \text{ V}$ ,  $GND = 0 \text{ V}$ , unless otherwise noted.

**Table 2.**

Parameter	+25°C	-55°C to +125°C	Unit	Test Conditions/Comments
<b>ANALOG SWITCH</b>				
Analog Signal Range		0 to $V_{DD}$	V	
On Resistance, $R_{ON}$	85 150	$\Omega_{typ}$ 200	$\Omega_{max}$	$V_{DD} = 4.5 \text{ V}, V_{SS} = 0 \text{ V}$ $V_S = 0 \text{ V} \text{ to } 4.5 \text{ V}, I_S = 1 \text{ mA}$
On Resistance Match Between Channels, $\Delta R_{ON}$	4.5 8	$\Omega_{typ}$ 10	$\Omega_{max}$	$V_S = 3.5 \text{ V}, I_S = 1 \text{ mA}$
On Resistance Flatness, $R_{FLAT(ON)}$	13	16	$\Omega_{typ}$	$V_{DD} = 5 \text{ V}, V_{SS} = 0 \text{ V}, V_S = 1.5 \text{ V} \text{ to } 4 \text{ V}, I_S = 1 \text{ mA}$
<b>LEAKAGE CURRENTS</b>				
Source Off Leakage, $I_S$ (OFF)	$\pm 0.005$		nA typ	$V_{DD} = 5.5 \text{ V}$
	$\pm 0.2$	$\pm 5$	nA max	$V_S = 1 \text{ V}/4.5 \text{ V}, V_D = 4.5 \text{ V}/1 \text{ V}$
Drain Off Leakage, $I_D$ (OFF)	$\pm 0.005$		nA typ	$V_S = 1 \text{ V}/4.5 \text{ V}, V_D = 4.5 \text{ V}/1 \text{ V}$
	$\pm 0.2$	$\pm 5$	nA max	
Channel On Leakage $I_D, I_S$ (ON)	$\pm 0.005$ $\pm 0.2$	$\pm 5$	nA typ nA max	$V_S = V_D = 1 \text{ V or } 4.5 \text{ V}$
<b>DIGITAL INPUTS</b>				
Input High Voltage, $V_{INH}$		2.4	V min	
Input Low Voltage, $V_{INL}$		0.8	V max	
Input Current $I_{INL}$ or $I_{INH}$	0.005	$\pm 1$	$\mu\text{A}_{typ}$ $\mu\text{A}_{max}$	$V_{IN} = V_{INL}$ or $V_{INH}$
Digital Input Capacitance, $C_{IN}$	2		pF typ	
<b>DYNAMIC CHARACTERISTICS<sup>1</sup></b>				
Transition Time, $t_{TRANSITION}$	120 200		ns typ ns max	$R_L = 300 \Omega, C_L = 35 \text{ pF}$ $V_S = 3 \text{ V}$
$\overline{\text{EN}}$ On Time, $t_{ON}(\overline{\text{EN}})$	120 190	300 280	ns typ ns max	$R_L = 300 \Omega, C_L = 35 \text{ pF}$ $V_S = 3 \text{ V}$
$\overline{\text{EN}}$ Off Time, $t_{OFF}(\overline{\text{EN}})$	35 50		ns typ ns max	$R_L = 300 \Omega, C_L = 35 \text{ pF}$ $V_S = 3 \text{ V}$
Break-Before-Make Time Delay, $t_{BBM}$	100	70 10	ns typ ns min	$R_L = 300 \Omega, C_L = 35 \text{ pF}$ $V_{S1} = V_{S2} = 3 \text{ V}$
Charge Injection	0.5 1		$\text{pC}_{typ}$ $\text{pC}_{max}$	$V_S = 2.5 \text{ V}, R_S = 0 \Omega, C_L = 1 \text{ nF}$
Off Isolation -3 dB Bandwidth	-90 180		$\text{dB}_{typ}$ $\text{MHz}_{typ}$	$R_L = 50 \Omega, C_L = 5 \text{ pF}, f = 1 \text{ MHz}$ $R_L = 50 \Omega, C_L = 5 \text{ pF}$
Source Capacitance, $C_S$ (OFF)	5		pF typ	$f = 1 \text{ MHz}$
Drain Capacitance, $C_D$ (OFF)	29		pF typ	$f = 1 \text{ MHz}$
$C_D, C_S$ (ON)	30		pF typ	$f = 1 \text{ MHz}$
<b>POWER REQUIREMENTS</b>				
Positive Power Supply Current, $I_{DD}$	0.01	1	$\mu\text{A}_{typ}$ $\mu\text{A}_{max}$	$V_{DD} = 5.5 \text{ V}$ Digital inputs = 0 V or 5.5 V

<sup>1</sup> Guaranteed by design; not subject to production test.

**2.7 V TO 3.6 V SINGLE SUPPLY**

$V_{DD}$  = 2.7 to 3.6 V,  $V_{SS}$  = 0 V, GND = 0 V, unless otherwise noted.

**Table 3.**

Parameter	+25°C	-55°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH				
Analog Signal Range		0 to $V_{DD}$	V	$V_{DD} = 2.7 \text{ V}, V_{SS} = 0 \text{ V}$
On Resistance, $R_{ON}$	185 300	$\Omega_{\text{typ}}$ $\Omega_{\text{max}}$	$\Omega$	$V_S = 0 \text{ V to } 2.7 \text{ V}, I_S = 0.1 \text{ mA}$
On Resistance Match Between Channels, $\Delta R_{ON}$	2 4.5	$\Omega_{\text{typ}}$ $\Omega_{\text{max}}$	$\Omega$	$V_S = 1.5 \text{ V}, I_S = 0.1 \text{ mA}$
LEAKAGE CURRENTS				
Source Off Leakage, $I_S$ (OFF)	$\pm 0.005$ $\pm 0.2$	$\pm 5$	nA typ nA max	$V_{DD} = 3.3 \text{ V}$ $V_S = 1 \text{ V}/3 \text{ V}, V_D = 3 \text{ V}/1 \text{ V}$
Drain Off Leakage, $I_D$ (OFF)	$\pm 0.005$ $\pm 0.2$	$\pm 5$	nA typ nA max	$V_S = 1 \text{ V}/3 \text{ V}, V_D = 3 \text{ V}/1 \text{ V}$
Channel On Leakage $I_D, I_S$ (ON)	$\pm 0.005$ $\pm 0.2$	$\pm 5$	nA typ nA max	$V_S = V_D = 1 \text{ V or } 3 \text{ V}$
DIGITAL INPUTS				
Input High Voltage, $V_{INH}$		2.0	V min	
Input Low Voltage, $V_{INL}$		0.5	V max	
Input Current $I_{INL}$ or $I_{INH}$	0.005	$\pm 1$	$\mu\text{A}$ typ $\mu\text{A}$ max	$V_{IN} = V_{INL}$ or $V_{INH}$
Digital Input Capacitance, $C_{IN}$	2		pF typ	
DYNAMIC CHARACTERISTICS <sup>1</sup>				
Transition Time, $t_{TRANSITION}$	200 370		ns typ ns max	$R_L = 300 \Omega, C_L = 35 \text{ pF}$ $V_S = 1.5 \text{ V}$
$\overline{\text{EN}}$ On Time, $t_{ON}(\overline{\text{EN}})$	230 370	490	ns typ ns max	$R_L = 300 \Omega, C_L = 35 \text{ pF}$ $V_S = 1.5 \text{ V}$
$\overline{\text{EN}}$ Off Time, $t_{OFF}(\overline{\text{EN}})$	50 80	490 110	ns typ ns max	$R_L = 300 \Omega, C_L = 35 \text{ pF}$ $V_S = 1.5 \text{ V}$
Break-Before-Make Time Delay, $t_{BBM}$	200	10	ns typ ns min	$R_L = 300 \Omega, C_L = 35 \text{ pF}$ $V_{S1} = V_{S2} = 1.5 \text{ V}$
Charge Injection	1 2		pC typ pC max	$V_S = 1.5 \text{ V}, R_S = 0 \Omega, C_L = 1 \text{ nF}$
Off Isolation	-90		dB typ	$R_L = 50 \Omega, C_L = 5 \text{ pF}, f = 1 \text{ MHz}$
-3 dB Bandwidth	160		MHz typ	$R_L = 50 \Omega, C_L = 5 \text{ pF}$
Source Capacitance, $C_S$ (OFF)	5		pF typ	$f = 1 \text{ MHz}$
Drain Capacitance, $C_D$ (OFF)	29		pF typ	$f = 1 \text{ MHz}$
$C_D, C_S$ (ON)	30		pF typ	$f = 1 \text{ MHz}$
POWER REQUIREMENTS				$V_{DD} = 3.6 \text{ V}$
Positive Power Supply Current, $I_{DD}$	0.01	1	$\mu\text{A}$ typ $\mu\text{A}$ max	Digital inputs = 0 V or 3.6 V

<sup>1</sup> Guaranteed by design; not subject to production test.

## ABSOLUTE MAXIMUM RATINGS

$T_A = 25^\circ\text{C}$ , unless otherwise noted.

Table 4.

Parameter	Rating
$V_{DD}$ to $V_{SS}$	13 V
$V_{DD}$ to GND	-0.3 V to +13 V
$V_{SS}$ to GND	+0.3 V to -6.5 V
Analog Inputs <sup>1</sup>	$V_{SS} - 0.3 \text{ V}$ to $V_{DD} + 0.3 \text{ V}$
Digital Inputs <sup>1</sup>	GND - 0.3 V to $V_{DD} + 0.3 \text{ V}$ or 10 mA, whichever occurs first
Peak Current, Sx or D (Pulsed at 1 ms, 10% duty cycle max)	40 mA
Continuous Current, Sx or D	20 mA
Operating Temperature Range	-55°C to +125°C
Storage Temperature Range	-65°C to +150°C
Junction Temperature	150°C
$\theta_{JA}$ Thermal Impedance 16-Lead TSSOP	150.4°C/W
Lead Temperature, Soldering Vapor Phase (60 sec)	215°C
Infrared (15 sec)	220°C
ESD (Human Body Model)	4.0 kV

<sup>1</sup> Overvoltages at  $A_x$ ,  $\overline{EN}$ , Sx, or D are clamped by internal diodes. Current must be limited to the maximum ratings.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

### ESD CAUTION



#### ESD (electrostatic discharge) sensitive device.

Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

Table 5. Truth Table

A2	A1	A0	$\overline{EN}$	Switch Condition
X <sup>1</sup>	X <sup>1</sup>	X <sup>1</sup>	1	None
0	0	0	0	1
0	0	1	0	2
0	1	0	0	3
0	1	1	0	4
1	0	0	0	5
1	0	1	0	6
1	1	0	0	7
1	1	1	0	8

<sup>1</sup> X means don't care

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

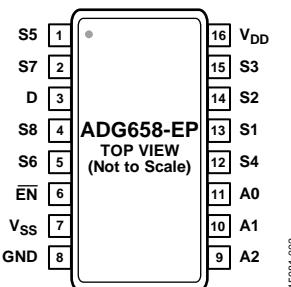


Figure 2. 16-Lead TSSOP Pin Configuration

Table 6. 16-Lead TSSOP Pin Function Descriptions

Pin No.	Mnemonic	Description
1, 2, 4, 5, 12, 13, 14, 15	S1 to S8	Source Terminals. Can be an input or output.
3	D	Drain Terminal. Can be an input or output.
6	$\overline{EN}$	Active Low Digital Input. When high, device is disabled and all switches are off. When low, Ax logic inputs determine on switch.
7	V <sub>ss</sub>	Most Negative Power Supply Potential.
8	GND	Ground (0 V) Reference.
9, 10, 11	A0 to A2	Logic Control Inputs.
16	V <sub>dd</sub>	Most Positive Power Supply Potential.

## TYPICAL PERFORMANCE CHARACTERISTICS

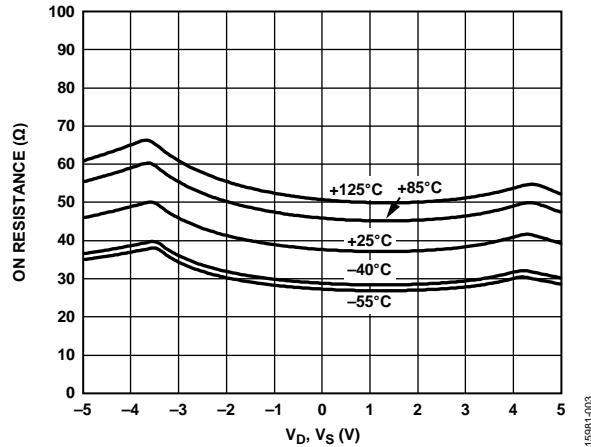


Figure 3. On Resistance vs.  $V_D$  ( $V_S$ ) for Different Temperatures (Dual Supply)

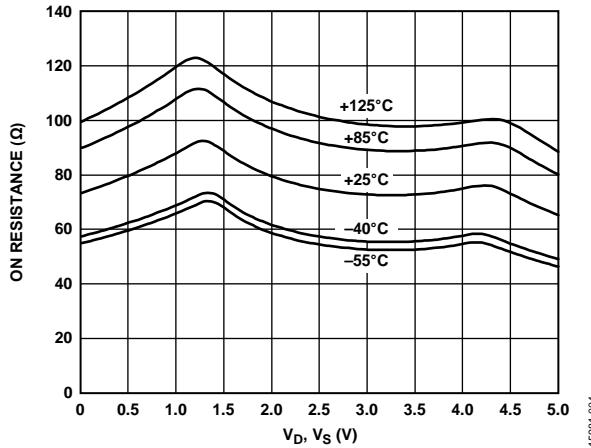


Figure 4. On Resistance vs.  $V_D$  ( $V_S$ ) for Different Temperatures (Single Supply)

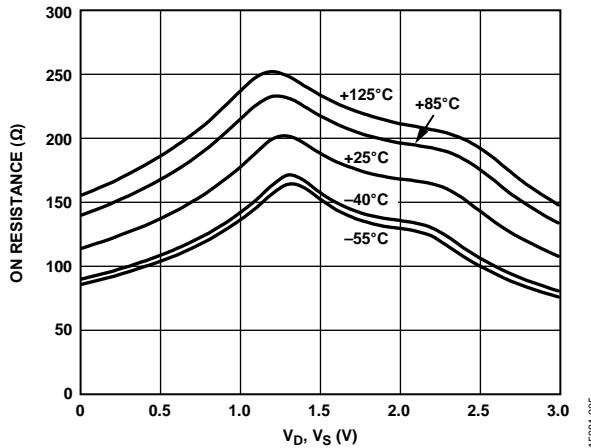


Figure 5. On Resistance vs.  $V_D$  ( $V_S$ ) for Different Temperatures (Single Supply)

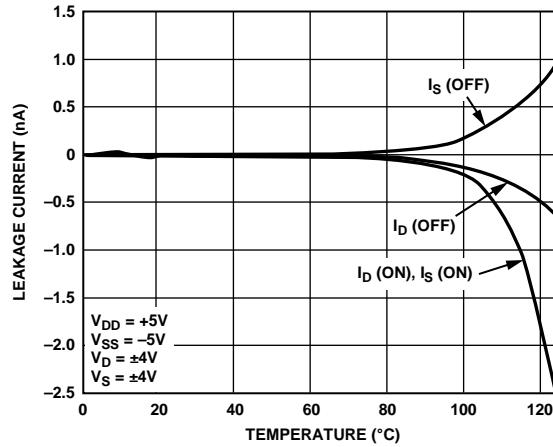


Figure 6. Leakage Current vs. Temperature (Dual Supply)

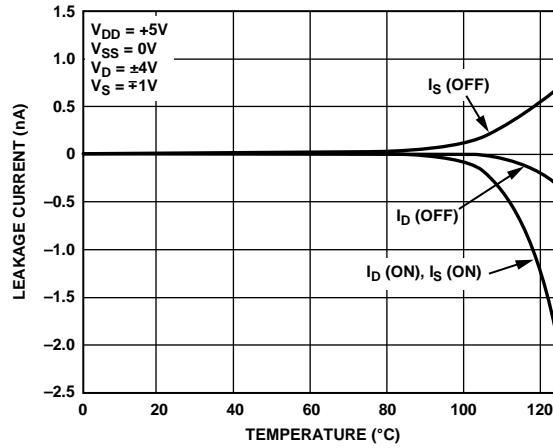
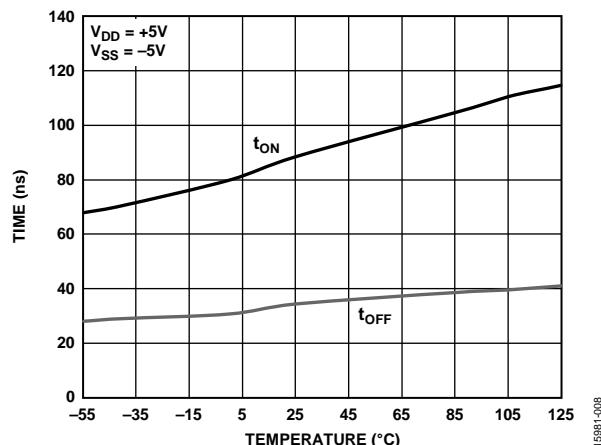
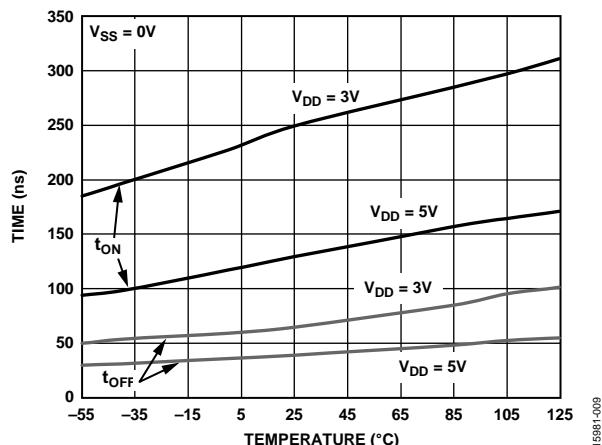
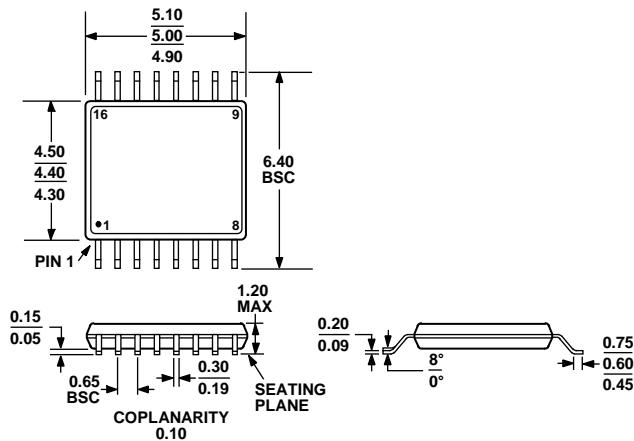


Figure 7. Leakage Current vs. Temperature (Single Supply)

Figure 8.  $t_{ON}/t_{OFF}$  Time vs. Temperature (Dual Supply)Figure 9.  $t_{ON}/t_{OFF}$  Time vs. Temperature (Single Supply)

## OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-153-AB

Figure 10. 16-Lead Thin Shrink Small Outline Package [TSSOP]

(RU-16)

Dimensions shown in millimeters

## ORDERING GUIDE

Model <sup>1</sup>	Temperature Range	Package Description	Package Option
ADG658TRUZ-EP	-55°C to +125°C	16-Lead Thin Shrink Small Outline Package [TSSOP]	RU-16
ADG658TRUZ-EP-RL7	-55°C to +125°C	16-Lead Thin Shrink Small Outline Package [TSSOP]	RU-16

<sup>1</sup> Z = RoHS Compliant Part.